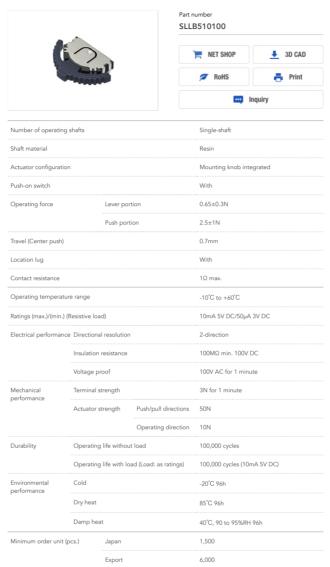
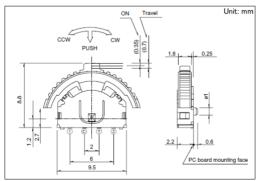
## **ALPS/ILPINE**

Switch Type Multi Control Device > SLLB5 Series > SLLB510100
Lever and Push Operation Type SLLB5 Series

# | Dimensions | Land Dimensions | Circuit Diagram | Code Table | Packing Specifications | | Soldering Condition |

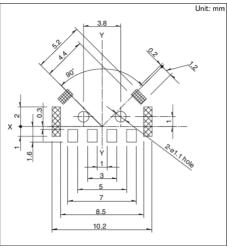


## Dimensions



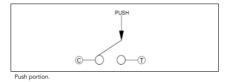
Land Dimensions



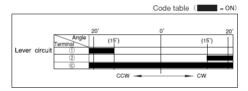


Viewed from mounting face.

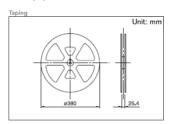
### Circuit Diagram



### Code Table



# Packing Specifications



| Number of packages<br>(pcs.) | 1 reel                     | 1,500       |
|------------------------------|----------------------------|-------------|
| (F)                          | 1 case / Japan             | 3,000       |
|                              | 1 case / export<br>packing | 6,000       |
| Tape width (mm)              |                            | 24          |
| Export package meas          | urements (mm)              | 428×413×172 |
|                              |                            |             |

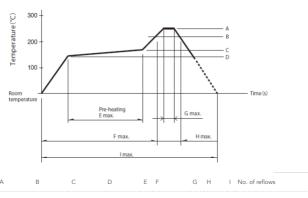
### Soldering Condition

Example of Reflow Soldering Condition

1. Heating method:
Double heating method with infrared heater.

2. Temperature measurement:
Thermocouple 0.1 to 0.2  $\Phi$  CA (K) or CC (T) at solder joints (copper foil surface). A heat resisting tape should be used to fix thermocouple.

3. Temperature profile





#### SLLB5 Series - Basic information

| 50°C | 230°C | 150°C | 150°C | - | 2 min. | - | 30s | - | 1 time |
|------|-------|-------|-------|---|--------|---|-----|---|--------|
|      |       |       |       |   |        |   |     |   |        |

(1) The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.

(2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

| Tip temperature | 350±5°C |  |
|-----------------|---------|--|
| Soldering time  | 3s max. |  |
| No. of solders  | 1 time  |  |

Notes are common to this series/models.

- This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
   Please place purchase orders for taping products per minimum order unit (1 reel or a case).
   Products other than those listed in the above chart are also available. Please contact us for details.
   Please contact us for automotive use products.

#### Inquiries about Products

